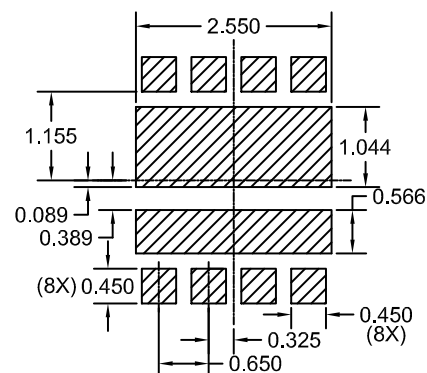
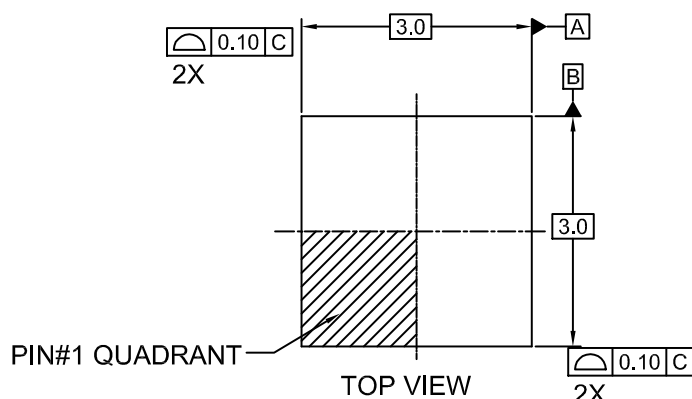
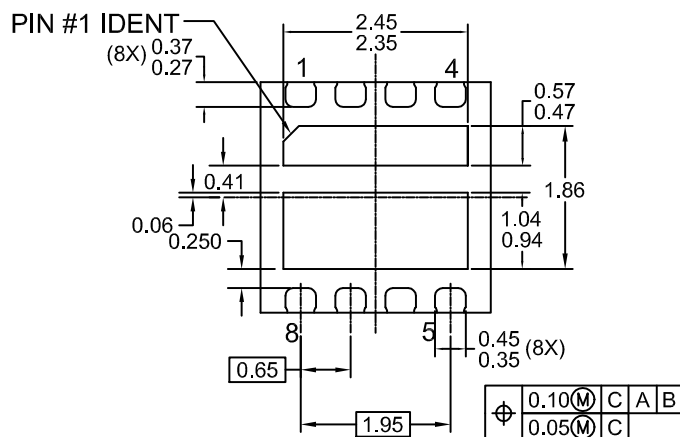
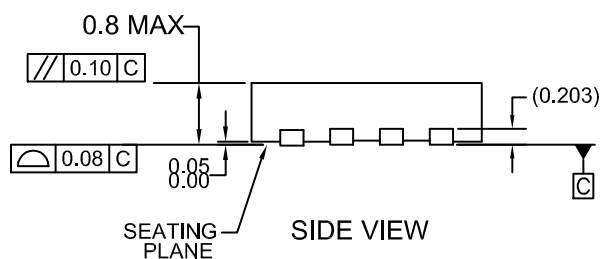


WDFN8 3x3, 0.65P
CASE 511DE
ISSUE O

DATE 31 AUG 2016



RECOMMENDED LAND PATTERN



BOTTOM VIEW

NOTES:

- A. DOES NOT CONFORM TO JEDEC
REGISTRATION MO-229
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER
ASME Y14.5M, 1994

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| DESCRIPTION: | WDFN8 3X3, 0.65P | PAGE 1 OF 1 |

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